

(2.00 mm) .0787"

**ESQT (-368), PTHF SERIES** 

# PC/104-PLUS™ SELF-NESTING SOCK

#### **SPECIFICATIONS**

For complete specifications and recommended PCB layouts see www.samtec.com?ESQT or www.samtec.com?PTHF

Insulator Material: Black Liquid Crystal Polymer (ESQT) Black High Temp Nylon (PTHF) Contact Material: Phosphor Bronze

Priosprior Bronze
Plating:
Au or Sn over
50 μ" (1.27 μm) Ni
Operating Temp Range:
-55 °C to +125 °C

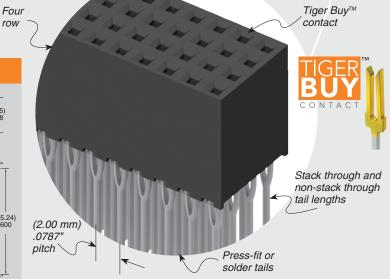
Normal Force: 60 grams (0.59 N) average Max Cycles: 100 with 10  $\mu$ " (0.25  $\mu$ m) Au RoHS Compliant:

Lead-Free Solderable: Yes (ESQT)

### Mates with:

ESQT, PTHF

## **APPLICATIONS** (9.35) ESQT-130-02-GF-Q-368 .368 or PTHF-130-02-GF-Q-368 Board 5 ATS-30-Q (15.24) ESQT-130-03-M-Q-368 or PTHF-130-03-M-Q-368



#### **RECOGNITIONS**

For complete scope of recognitions see www.samtec.com/quality



### **TYPE** NO. PINS **STRIP** PER ROW **ESQT** 30

LEAD

\_ 02

-03

(11.63) .458

= Solder

**PTHF** 

= Press-fit

**Tails** 

chart **ESQT PTHF** 

В

(3.00) (12.34)

В

(2.29)

.090

(21.59) (12.24) (21.59) (12.24) .850 .482 .850 .482

486

Specify LEAD **STYLE** from

**LEAD** 

STYLE

## **PLATING OPTION**





ALSO AVAILABLE

(MOQ Required)

· Other platings

Contact Samtec.

-GF = 15 μ" (0.38 μm) Gold on contact, Gold flash on tail (–02 Lead Style only)

= 20  $\mu$ " (0.51  $\mu$ m) Gold on contact, Matte Tin on tail (-03 Lead Style only)

#### **TOOLING**

 Press-fit tooling Contact Samtec.

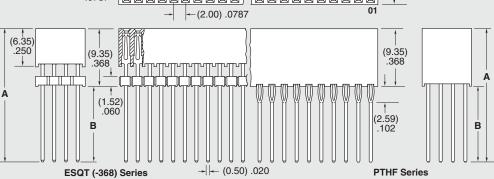
#### **OTHER SOLUTIONS**



Paste In Hole (PIH) processing. Contact Samtec ASP Group. (Not recommended for stack through applications) ESQT only.

Note: Some lengths, styles and options are non-standard, non-returnable.

#### (60.30) 2.374 04 (2.00)0787 **←**(2.00) .0787



Due to technical progress, all designs, specifications and components are subject to change without notice